



- NOTES:**
- 1.PLATING THICKNESS
 Ni:1.27~8.89 MICRON.
 Au:0.30 MICRON MIN.
 (EXCEPT 0.30~1.00 MICRON AT SOLDER PADS.)
 - 2.CONNECTION.
 (A-C),(B-D),(B-2-S/R),(F-3),(G-J-4),(H-1)
 - 3.CAMBER : 50.00 MICRON MAX.
 - 4.METALLIZATION RUNDOWN 0.20 MAX.
 - 5.EXPOSURE OF CERAMIC SURFACE AND METALLIZED PATTERN OCCURRED BY MISALIGNMENT OF THE UPPER LAYER, SHALL BE ALLOWED.
 - 6.■ PART TO BE SHOWN AS SIDE METALLIZED PATTERN.
 - 7.* MARK TO BE MATERIAL DIMENSION.
 - 8.SEALING METHOD OF THIS PRODUCT SHALL BE SEAM WELD.

TOLERANCE * XX ±1% XXX N.L.T.±0.13 ANGLES	REVISION	SBB ATTACHED EXCEPTIONS SHEET.				TITLE	7050 OSC B
	SCALE	DIMENSION	PROJECTION	CUSTOMER DWG NO.	REV.	PART NO.	
	12 : 1	mm	3rd			S5070CLK5	REV. 0
MATERIAL	APPROVED	CHECKED	ENGRG	CHECKED	DESIGNED	DWG NO.	SHT/OF
90%MIN.A1203 (NA-311B BLACK)	Shigetomi	Yamahata	Ohba	Kumura	Sugi		1/8
	Mar.06.02	Mar.06.02	Mar.05.02	Mar.05.02	Mar.05.02		